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(12) **United States Design Patent**
Liu

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(54) **EARPHONE**

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(52) **U.S. Cl.**
USPC **D14/223**

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D24/174; 128/864, 865, 866; 381/380,
381/381, 322, 328; 455/90.3, 575.1,
455/569.1

CPC H04R 1/10; H04R 25/00; H04R 25/02;
H04R 1/1066; H04R 5/033; H04R
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See application file for complete search history.

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Primary Examiner — Paula Allen Greene

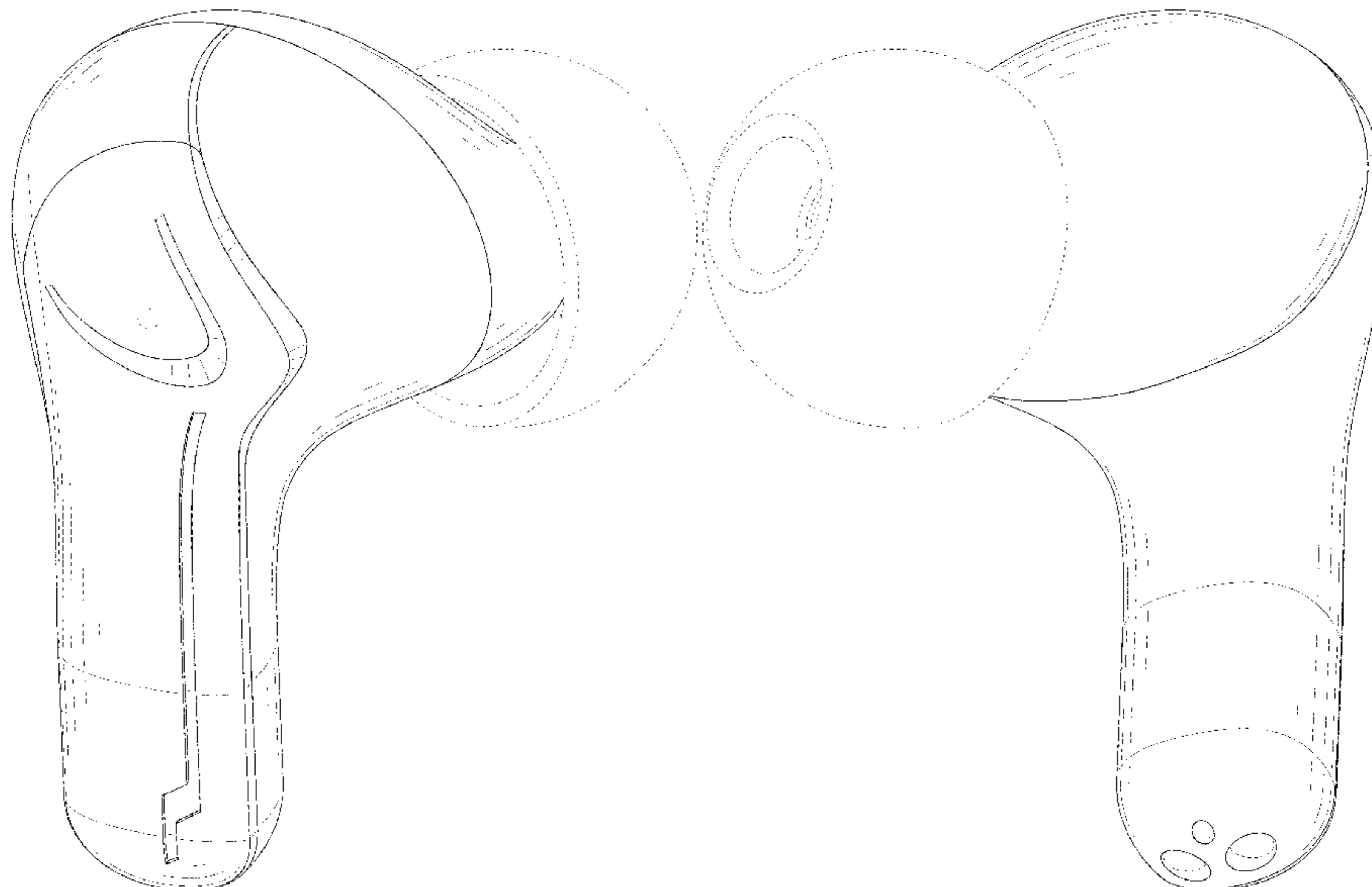
(57) **CLAIM**

The ornamental design for an earphone, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of an earphone showing my new design;
 FIG. 2 is another perspective view thereof;
 FIG. 3 is a front elevational view thereof;
 FIG. 4 is a rear elevational view thereof;
 FIG. 5 is a left side elevational view thereof;
 FIG. 6 is a right side elevational view thereof;
 FIG. 7 is a top plan view thereof;
 FIG. 8 is a bottom plan view thereof; and,
 FIG. 9 is a perspective of the earphone where the earphone is received in a charging case.
 The broken lines in the drawings depict portions of the earphone that form no part of the claimed design.

1 Claim, 9 Drawing Sheets



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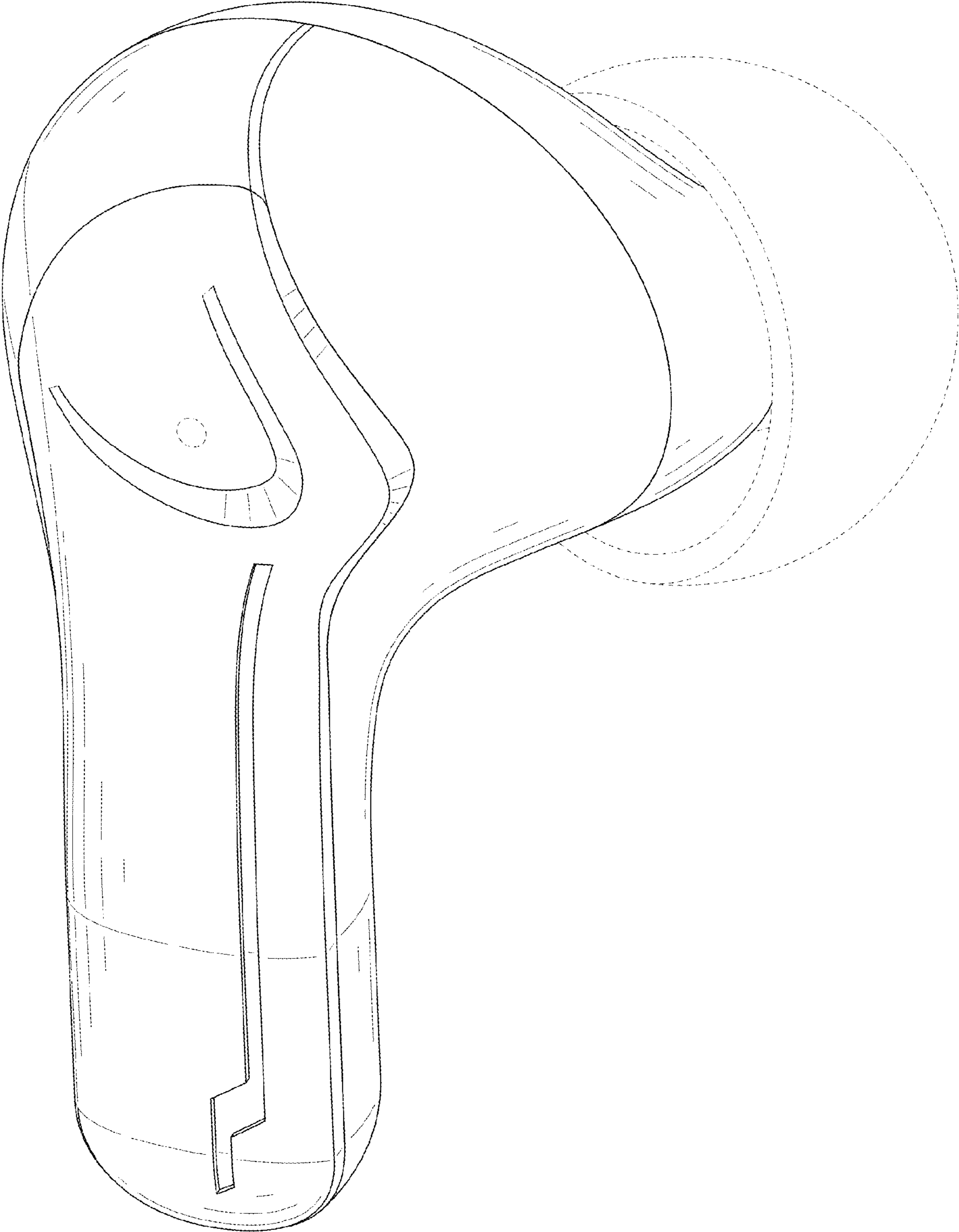


FIG. 1

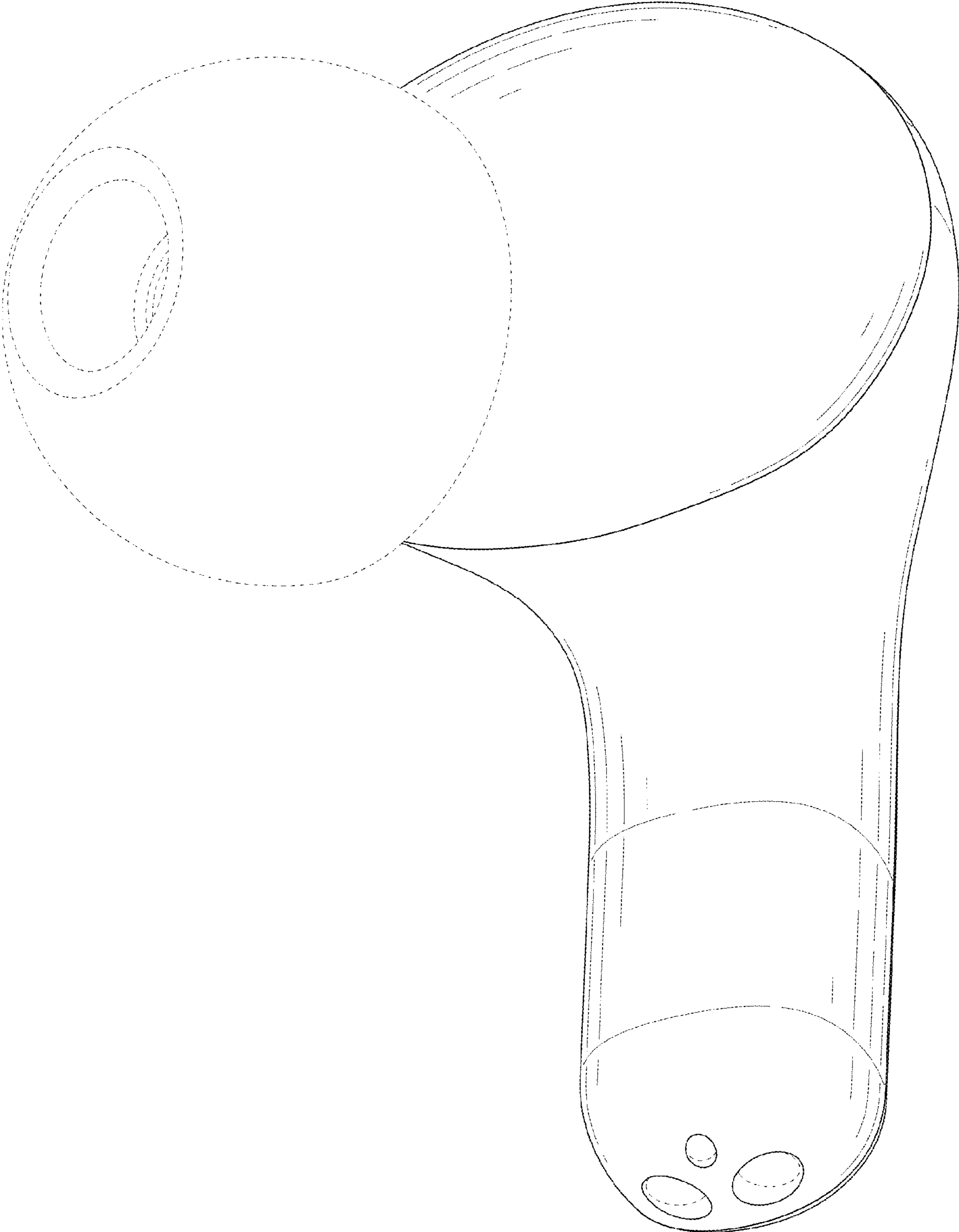


FIG. 2

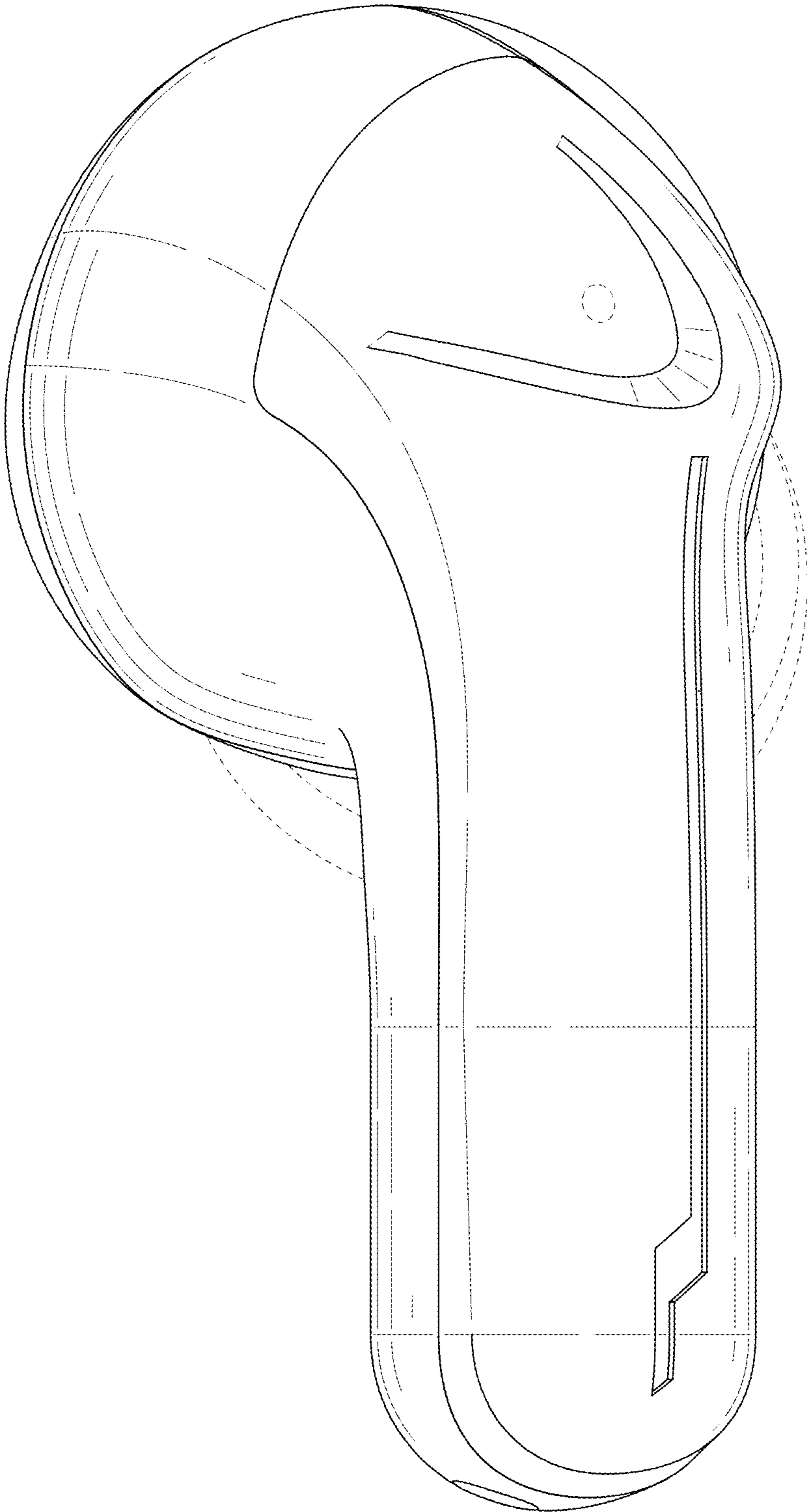


FIG. 3

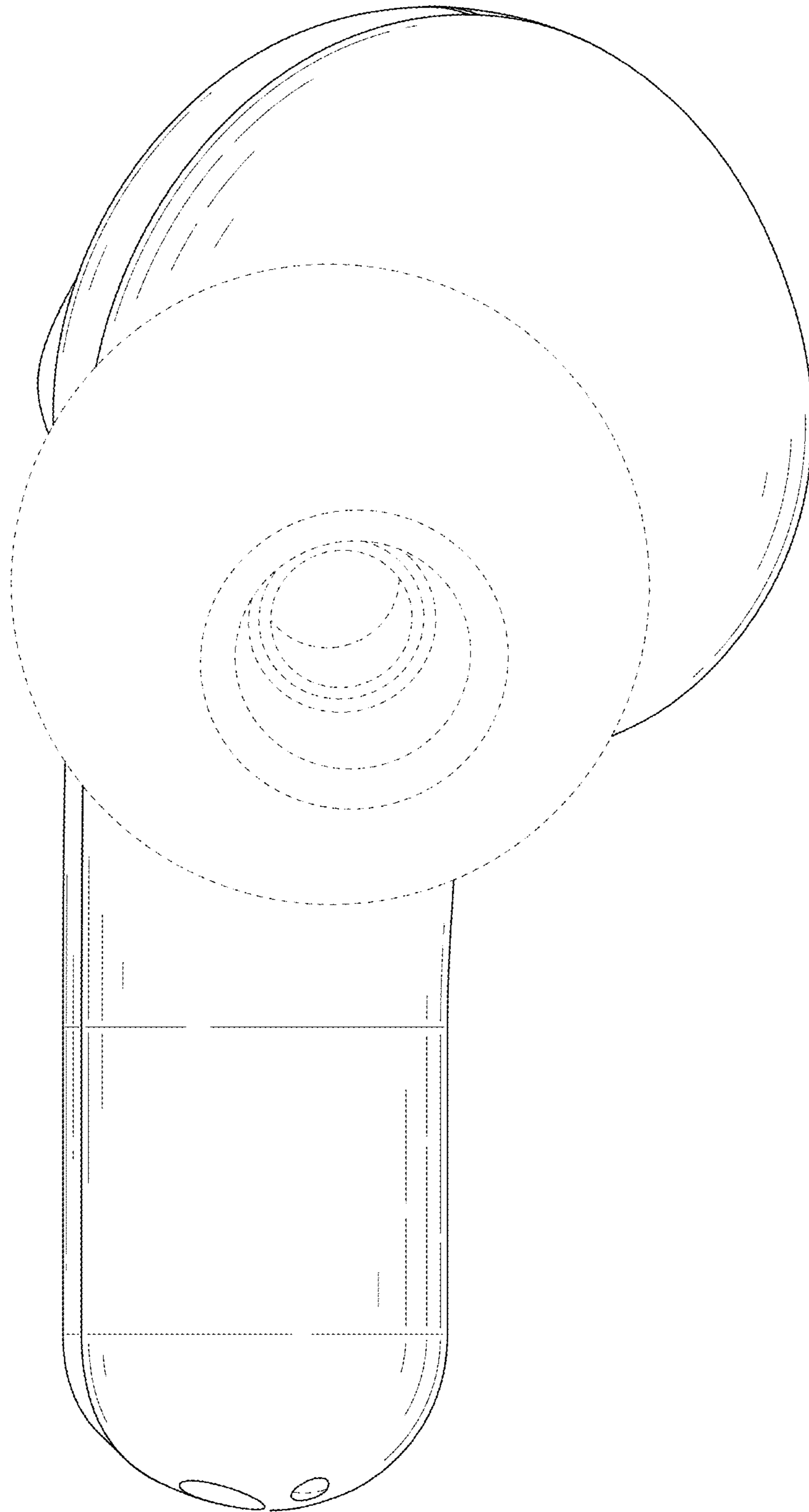


FIG. 4

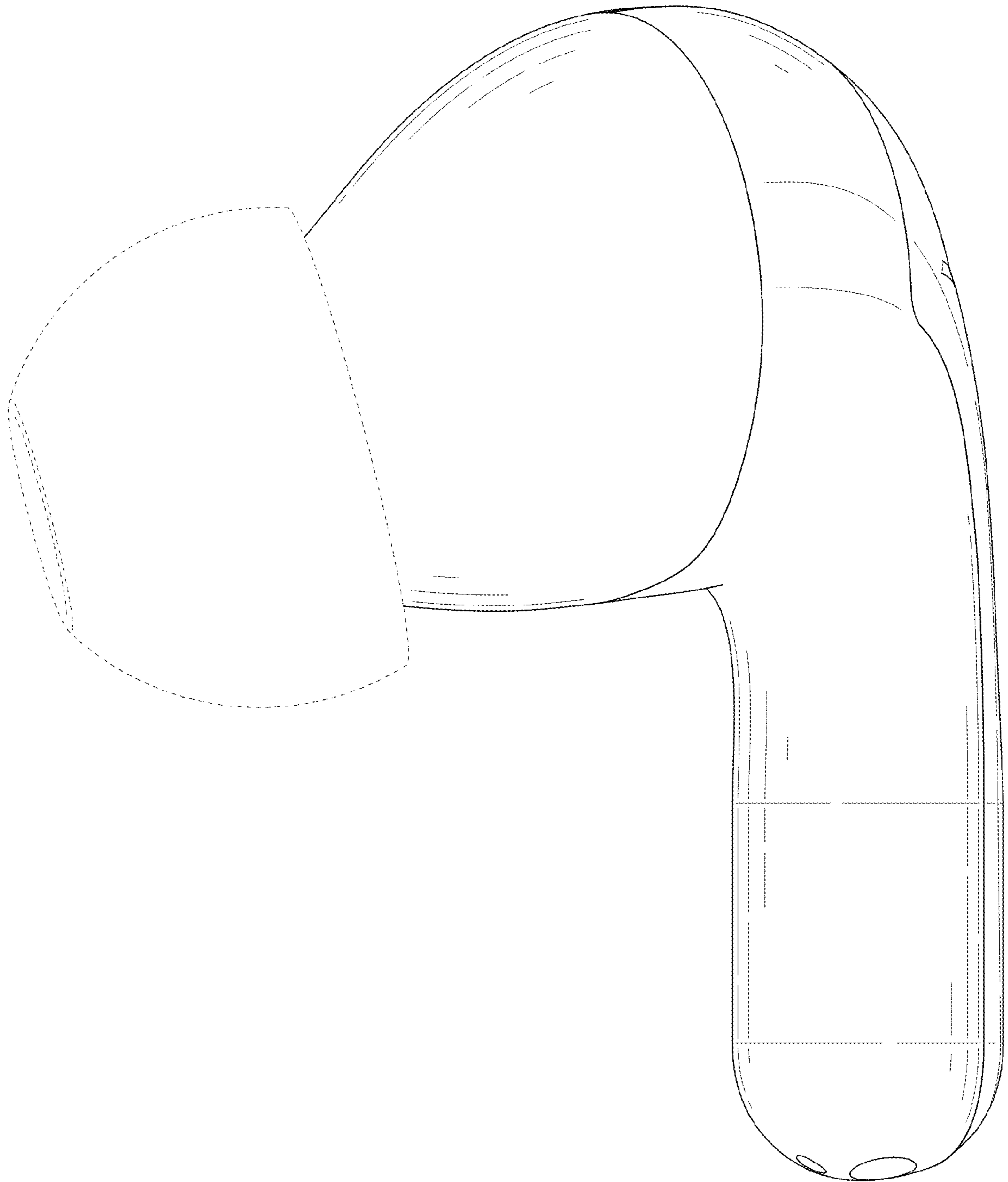


FIG. 5

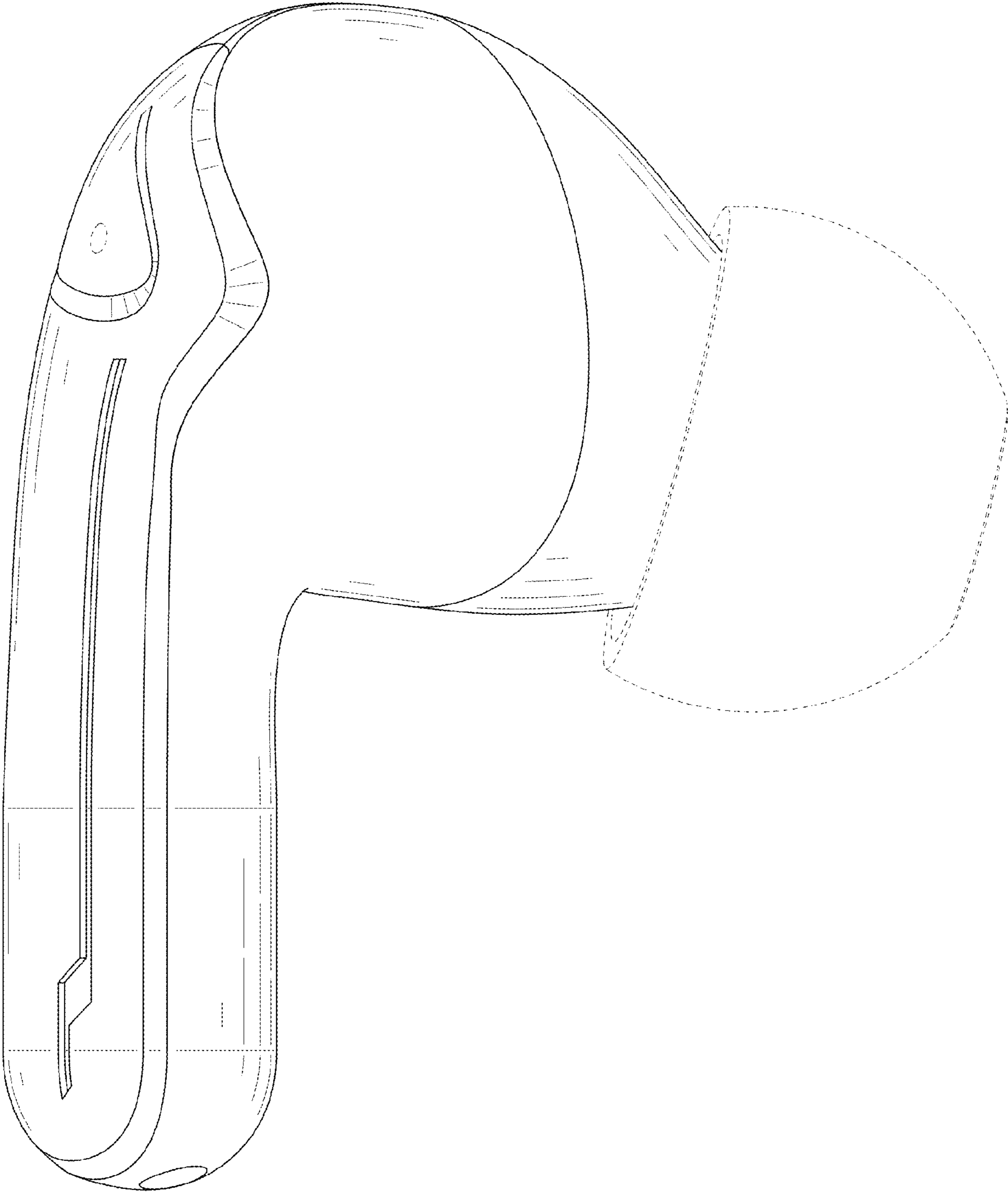


FIG. 6

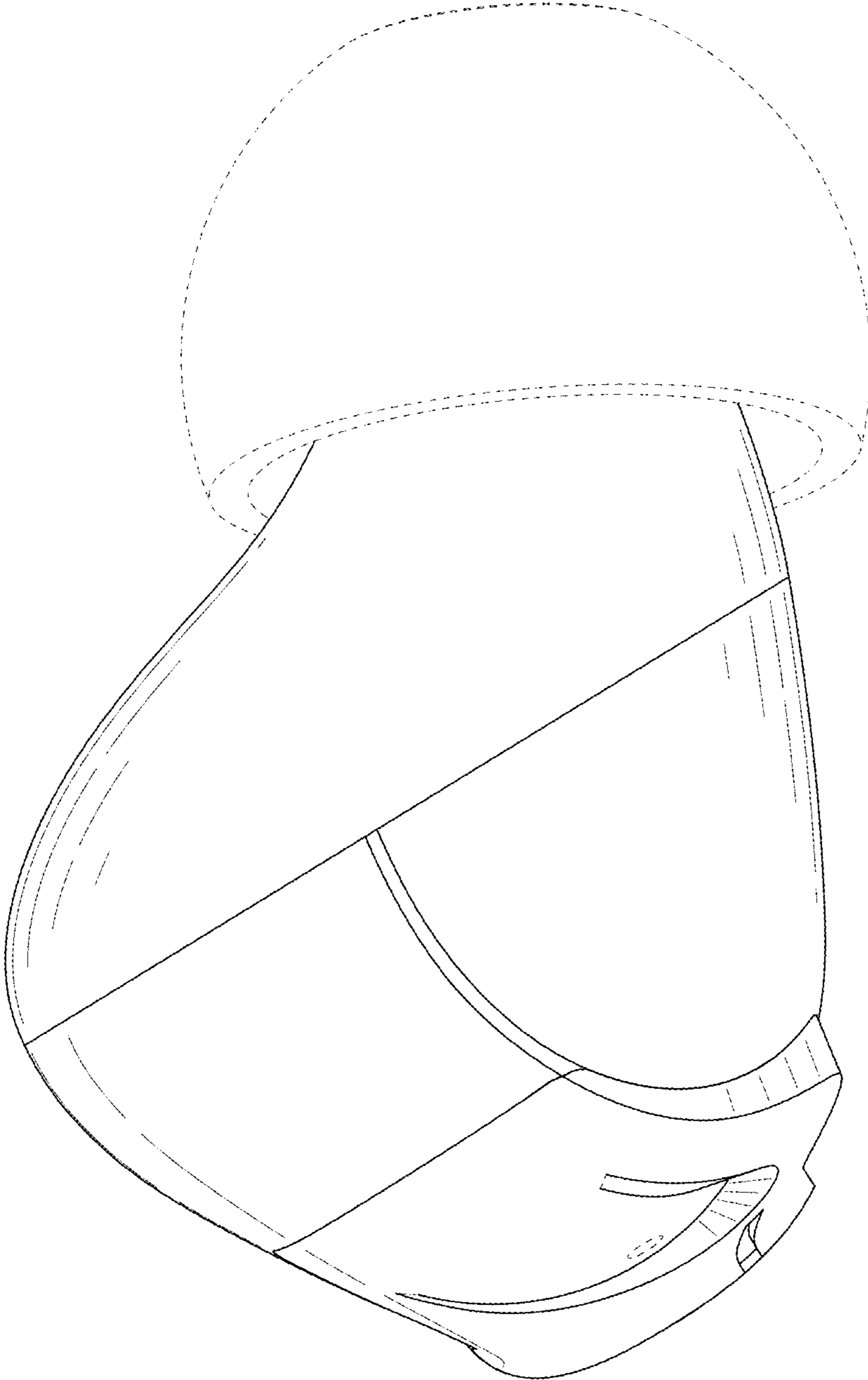


FIG. 7

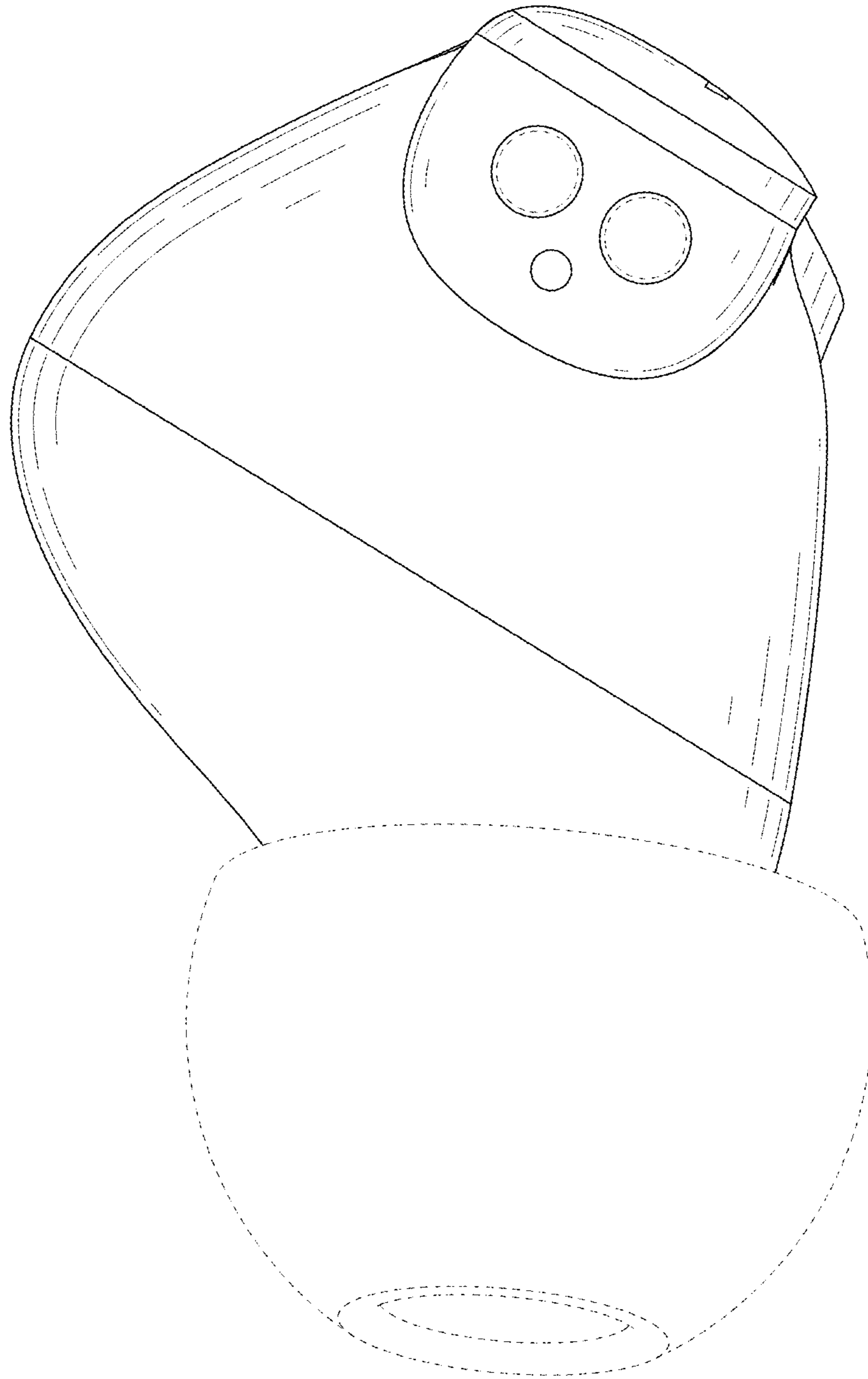


FIG. 8



FIG. 9